# imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





Is Now Part of



## **ON Semiconductor**®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor dates sheds, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor dates sheds and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use on similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor and its officers, employees, subsidiaries, affliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconduc

Aug 2015



## FSB50760SFS Motion SPM<sup>®</sup> 5 SuperFET<sup>®</sup> Series

## Features

- UL Certified No. E209204 (UL1557)
- 600 V  $R_{DS(on)}$  = 530 m $\Omega$ (Max) SuperFET MOSFET 3-Phase Inverter with Gate Drivers and Protection
- · Built-in Bootstrap Diodes Simplify PCB Layout
- Separate Open-Source Pins from Low-Side MOS-FETS for Three-Phase Current-Sensing
- Active-HIGH Interface, Works with 3.3 / 5 V Logic, Schmitt-trigger Input
- · Optimized for Low Electromagnetic Interference
- HVIC Temperature-Sensing Built-in for Temperature Monitoring
- · HVIC for Gate Driving and Under-Voltage Protection
- Isolation Rating: 1500 Vrms / 1 min.
- Moisture Sensitive Level (MSL) 3
- RoHS Compliant

## **Applications**

 3-Phase Inverter Driver for Small Power AC Motor Drives

## **Related Source**

- <u>RD-402 Reference Design for Motion SPM\_5 Super-</u> <u>FET Series</u>
- <u>AN-9082 Motion SPM5 Series Thermal Performance</u> <u>by Contact Pressure</u>
- AN-9080 User's Guide for Motion SPM 5 Series V2

## **General Description**

The FSB50760SFS is an advanced Motion SPM<sup>®</sup> 5 module providing a fully-featured, high-performance inverter output stage for AC Induction, BLDC and PMSM motors such as refrigerators, fans and pumps. These modules integrate optimized gate drive of the built-in MOSFETs(SuperFET<sup>®</sup> technology) to minimize EMI and while also providing multiple losses, on-module protection features including under-voltage lockouts and high-speed thermal monitoring. The built-in HVIC requires only a single supply voltage and translates the incoming logic-level gate inputs to the high-voltage, high-current drive signals required to properly drive the module's internal MOSFETs. Separate open-source MOSFET terminals are available for each phase to support the widest variety of control algorithms.



## 3D Package Drawing (Click to Activate 3D Content)

## Package Marking & Ordering Information

| Device Marking | Device      | Package   | Reel Size | Packing Type | Quantity |
|----------------|-------------|-----------|-----------|--------------|----------|
| 50760SFS       | FSB50760SFS | SPM5Q-023 | 330mm     | Tape-Reel    | 450      |

## **Absolute Maximum Ratings**

Inverter Part (each MOSFET unless otherwise specified.)

| Symbol             | Parameter                             | Conditions                                      | Rating | Unit             |
|--------------------|---------------------------------------|-------------------------------------------------|--------|------------------|
| V <sub>DSS</sub>   | Drain-Source Voltage of Each MOSFET   |                                                 | 600    | V                |
| *I <sub>D 25</sub> | Each MOSFET Drain Current, Continuous | $T_{\rm C} = 25^{\circ}{\rm C}$                 | 3.6    | A                |
| *I <sub>D 80</sub> | Each MOSFET Drain Current, Continuous | $T_{\rm C} = 80^{\circ}{\rm C}$                 | 2.7    | A                |
| *I <sub>DP</sub>   | Each MOSFET Drain Current, Peak       | T <sub>C</sub> = 25°C, PW < 100 μs              | 9.4    | A                |
| *I <sub>DRMS</sub> | Each MOSFET Drain Current, Rms        | $T_{C} = 80^{\circ}C, F_{PWM} < 20 \text{ kHz}$ | 1.9    | A <sub>rms</sub> |
| *P <sub>D</sub>    | Maximum Power Dissipation             | $T_{C} = 25^{\circ}C$ , For Each MOSFET         | 14.5   | W                |

## Control Part (each HVIC unless otherwise specified.)

| Symbol          | Parameter              | Conditions                              | Rating                   | Unit |
|-----------------|------------------------|-----------------------------------------|--------------------------|------|
| V <sub>CC</sub> | Control Supply Voltage | Applied Between $V_{CC}$ and COM        | 20                       | V    |
| V <sub>BS</sub> | High-side Bias Voltage | Applied Between $\rm V_B$ and $\rm V_S$ | 20                       | V    |
| V <sub>IN</sub> | Input Signal Voltage   | Applied Between IN and COM              | $-0.3 \sim V_{CC} + 0.3$ | V    |

Bootstrap Diode Part (each bootstrap diode unless otherwise specified.)

| Symbol             | Parameter                          | Conditions                                   | Rating | Unit |
|--------------------|------------------------------------|----------------------------------------------|--------|------|
| V <sub>RRMB</sub>  | Maximum Repetitive Reverse Voltage |                                              | 600    | V    |
| * I <sub>FB</sub>  | Forward Current                    | $T_{\rm C} = 25^{\circ}{\rm C}$              | 0.5    | A    |
| * I <sub>FPB</sub> | Forward Current (Peak)             | T <sub>C</sub> = 25°C, Under 1ms Pulse Width | 1.5    | A    |

## **Thermal Resistance**

| Symbol                | Parameter                           | Conditions                                                       | Rating | Unit |
|-----------------------|-------------------------------------|------------------------------------------------------------------|--------|------|
| $R_{	extsf{	heta}JC}$ | Junction to Case Thermal Resistance | Each MOSFET under Inverter Oper-<br>ating Condition (1st Note 1) | 8.6    | °C/W |

## **Total System**

| Symbol           | Parameter                      | Conditions                                                        | Rating    | Unit             |
|------------------|--------------------------------|-------------------------------------------------------------------|-----------|------------------|
| Τ <sub>J</sub>   | Operating Junction Temperature |                                                                   | -40 ~ 150 | °C               |
| T <sub>STG</sub> | Storage Temperature            |                                                                   | -40 ~ 125 | °C               |
| V <sub>ISO</sub> | Isolation Voltage              | 60 Hz, Sinusoidal, 1 Minute, Con-<br>nect Pins to Heat Sink Plate | 1500      | V <sub>rms</sub> |

1st Notes:

1. For the measurement point of case temperature  $T_{C},$  please refer to Figure 4.

2. Marking "\* " is calculation value or design factor.

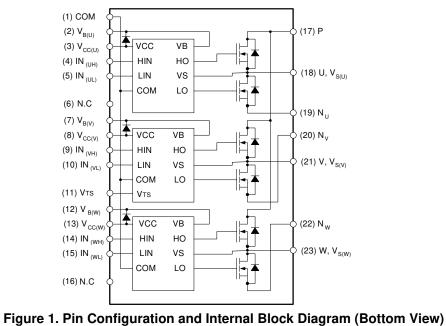
|                                     | FSB                            |
|-------------------------------------|--------------------------------|
| Pin Description                     | FSB50760SFS                    |
|                                     | 309                            |
| e MOSFET Driving                    | Ĩ                              |
| ow-Side MOSFET Driving              |                                |
|                                     | ≤o                             |
|                                     | tio                            |
|                                     | ž                              |
| MOSFET Driving                      | SP                             |
| w Side MOSFET Driving               | M                              |
|                                     | сл<br>U                        |
|                                     | Motion SPM® 5 SuperFET® Series |
| ing                                 | <u>d</u>                       |
| e MOSFET Driving                    | erF                            |
| ow-Side MOSFET Driving              | щ                              |
| 9                                   | B                              |
|                                     | Se                             |
|                                     | Prie                           |
|                                     | Š                              |
| Ground for High-Side MOSFET Driving |                                |
| e                                   |                                |
| e                                   |                                |
| Ground for High-Side MOSFET Driving |                                |

## **Pin descriptions**

Pin Name

**Pin Number** 

|    |                      | •                                                                     |
|----|----------------------|-----------------------------------------------------------------------|
| 1  | COM                  | IC Common Supply Ground                                               |
| 2  | V <sub>B(U)</sub>    | Bias Voltage for U-Phase High-Side MOSFET Driving                     |
| 3  | V <sub>CC(U)</sub>   | Bias Voltage for U-Phase IC and Low-Side MOSFET Driving               |
| 4  | IN <sub>(UH)</sub>   | Signal Input for U-Phase High-Side                                    |
| 5  | IN <sub>(UL)</sub>   | Signal Input for U-Phase Low-Side                                     |
| 6  | N.C                  | No Connection                                                         |
| 7  | V <sub>B(V)</sub>    | Bias Voltage for V-Phase High Side MOSFET Driving                     |
| 8  | V <sub>CC(V)</sub>   | Bias Voltage for V-Phase IC and Low Side MOSFET Driving               |
| 9  | IN <sub>(VH)</sub>   | Signal Input for V-Phase High-Side                                    |
| 10 | IN <sub>(VL)</sub>   | Signal Input for V-Phase Low-Side                                     |
| 11 | V <sub>TS</sub>      | Output for HVIC Temperature Sensing                                   |
| 12 | V <sub>B(W)</sub>    | Bias Voltage for W-Phase High-Side MOSFET Driving                     |
| 13 | V <sub>CC(W)</sub>   | Bias Voltage for W-Phase IC and Low-Side MOSFET Driving               |
| 14 | IN <sub>(WH)</sub>   | Signal Input for W-Phase High-Side                                    |
| 15 | IN <sub>(WL)</sub>   | Signal Input for W-Phase Low-Side                                     |
| 16 | N.C                  | No Connection                                                         |
| 17 | Р                    | Positive DC-Link Input                                                |
| 18 | U, V <sub>S(U)</sub> | Output for U-Phase & Bias Voltage Ground for High-Side MOSFET Driving |
| 19 | NU                   | Negative DC-Link Input for U-Phase                                    |
| 20 | Nv                   | Negative DC-Link Input for V-Phase                                    |
| 21 | V, V <sub>S(V)</sub> | Output for V-Phase & Bias Voltage Ground for High-Side MOSFET Driving |
| 22 | N <sub>W</sub>       | Negative DC-Link Input for W-Phase                                    |
| 23 | W, V <sub>S(W)</sub> | Output for W Phase & Bias Voltage Ground for High-Side MOSFET Driving |



#### 1st Notes:

3. Source terminal of each low-side MOSFET is not connected to supply ground or bias voltage ground inside Motion SPM<sup>®</sup> 5 product. External connections should be made as indicated in Figure 3.

## **Electrical Characteristics** ( $T_J$ = 25°C, $V_{CC}$ = $V_{BS}$ = 15 V unless otherwise specified.)

| Symbol              | Parameter                                   | Conditions                                                                                                                                                                                                                                        | Min | Тур  | Max    | Unit |
|---------------------|---------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----|------|--------|------|
| BV <sub>DSS</sub>   | Drain - Source<br>Breakdown Voltage         | V <sub>IN</sub> = 0 V, I <sub>D</sub> = 1 mA (2nd Note 1)                                                                                                                                                                                         | 600 | -    | -      | V    |
| I <sub>DSS</sub>    | Zero Gate Voltage<br>Drain Current          | V <sub>IN</sub> = 0 V, V <sub>DS</sub> = 600 V                                                                                                                                                                                                    | -   | -    | 1      | mA   |
| R <sub>DS(on)</sub> | Static Drain - Source<br>Turn-On Resistance | $V_{CC} = V_{BS} = 15 \text{ V}, V_{IN} = 5 \text{ V}, I_D = 2 \text{ A}$                                                                                                                                                                         | -   | 460  | 530    | mΩ   |
| V <sub>SD</sub>     | Drain - Source Diode<br>Forward Voltage     | $V_{CC} = V_{BS} = 15 \text{ V}, V_{IN} = 0 \text{ V}, I_D = -2 \text{ A}$                                                                                                                                                                        | -   | -    | 1.1    | V    |
| t <sub>ON</sub>     |                                             | V <sub>PN</sub> = 300 V, V <sub>CC</sub> = V <sub>BS</sub> = 15 V, I <sub>D</sub> = 2 A                                                                                                                                                           | -   | 1200 | -      | ns   |
| t <sub>OFF</sub>    |                                             |                                                                                                                                                                                                                                                   | -   | 970  | -      | ns   |
| t <sub>rr</sub>     | Switching Times                             | $V_{IN} = 0 V \leftrightarrow 5 V$ , Inductive Load L = 3 mH<br>High- and Low-Side MOSFET Switching                                                                                                                                               | -   | 160  | -      | ns   |
| E <sub>ON</sub>     |                                             | (2nd Note 2)                                                                                                                                                                                                                                      | -   | 120  | -      | μJ   |
| E <sub>OFF</sub>    |                                             |                                                                                                                                                                                                                                                   | -   | 10   | -      | μJ   |
| RBSOA               | Reverse Bias Safe Oper-<br>ating Area       | $      V_{PN} = 400 \text{ V},  \text{V}_{CC} = \text{V}_{BS} = 15 \text{ V},  \text{I}_{D} = \text{I}_{DP},  \text{V}_{DS} = \text{BV}_{DSS}, \\ \text{T}_{J} = 150^{\circ}\text{C} \\ \text{High- and Low-Side MOSFET Switching (2nd Note 3)} $ |     | Full | Square |      |

**Inverter Part** (each MOSFET unless otherwise specified.)

### Control Part (each HVIC unless otherwise specified.)

| Symbol            | Parameter                                    |                                                          | Conditions                                                                          | Min | Тур | Max | Unit |
|-------------------|----------------------------------------------|----------------------------------------------------------|-------------------------------------------------------------------------------------|-----|-----|-----|------|
| lacc              | Quiescent V <sub>CC</sub> Current            | $V_{CC} = 15 V,$<br>$V_{IN} = 0 V$                       | Applied Between V <sub>CC</sub> and COM                                             | -   | -   | 200 | μA   |
| I <sub>QBS</sub>  | Quiescent V <sub>BS</sub> Current            | V <sub>BS</sub> = 15 V,<br>V <sub>IN</sub> = 0 V         | Applied Between V <sub>B(U)</sub> - U, V <sub>B(V)</sub> - V, V <sub>B(W)</sub> - W | -   | -   | 100 | μA   |
| UV <sub>CCD</sub> | Low-Side Under-Voltage                       | V <sub>CC</sub> Under-Voltage Protection Detection Level |                                                                                     | 7.4 | 8.0 | 9.4 | V    |
| UV <sub>CCR</sub> | Protection (Figure 8)                        | V <sub>CC</sub> Under-Voltage Protection Reset Level     |                                                                                     | 8.0 | 8.9 | 9.8 | V    |
| UV <sub>BSD</sub> | High-Side Under-Voltage                      | V <sub>BS</sub> Under-Voltage                            | V <sub>BS</sub> Under-Voltage Protection Detection Level                            |     | 8.0 | 9.4 | V    |
| UV <sub>BSR</sub> | Protection (Figure 9)                        | V <sub>BS</sub> Under-Voltage Protection Reset Level     |                                                                                     | 8.0 | 8.9 | 9.8 | ۷    |
| V <sub>TS</sub>   | HVIC Temperature Sens-<br>ing Voltage Output | V <sub>CC</sub> = 15 V, T <sub>HVIC</sub> =              | V <sub>CC</sub> = 15 V, T <sub>HVIC</sub> = 25°C (2nd Note 4)                       |     | 790 | 980 | mV   |
| V <sub>IH</sub>   | ON Threshold Voltage                         | Logic HIGH Level                                         | Applied between IN and COM                                                          | -   | -   | 2.9 | V    |
| V <sub>IL</sub>   | OFF Threshold Voltage                        | Logic LOW Level                                          | Applied between IN and COM                                                          | 0.8 | -   | -   | V    |

Bootstrap Diode Part (each bootstrap diode unless otherwise specified.)

| Symbol           | Parameter             | Conditions                                                    | Min | Тур | Max | Unit |
|------------------|-----------------------|---------------------------------------------------------------|-----|-----|-----|------|
| V <sub>FB</sub>  | Forward Voltage       | $I_F = 0.1 \text{ A}, T_C = 25^{\circ}C \text{ (2nd Note 5)}$ | -   | 2.5 | -   | V    |
| t <sub>rrB</sub> | Reverse Recovery Time | I <sub>F</sub> = 0.1 A, T <sub>C</sub> = 25°C                 | -   | 80  | -   | ns   |

2nd Notes:

1. BV<sub>DSS</sub> is the absolute maximum voltage rating between drain and source terminal of each MOSFET inside Motion SPM<sup>®</sup> 5 product. V<sub>PN</sub> should be sufficiently less than this value considering the effect of the stray inductance so that V<sub>PN</sub> should not exceed BV<sub>DSS</sub> in any case.

2. t<sub>ON</sub> and t<sub>OFF</sub> include the propagation delay of the internal drive IC. Listed values are measured at the laboratory test condition, and they can be different according to the field applications due to the effect of different printed circuit boards and wirings. Please see Figure 6 for the switching time definition with the switching test circuit of Figure 7.

3. The peak current and voltage of each MOSFET during the switching operation should be included in the Safe Operating Area (SOA). Please see Figure 7 for the RBSOA test circuit that is same as the switching test circuit.

4.  $V_{ts}$  is only for sensing-temperature of module and cannot shutdown MOSFETs automatically.

5. Built-in bootstrap diode includes around 15  $\Omega$  resistance characteristic. Please refer to Figure 2.

| Symbol               | Parameter                                 | Conditions                                                                          | Min. | Тур. | Max.            | Unit |
|----------------------|-------------------------------------------|-------------------------------------------------------------------------------------|------|------|-----------------|------|
| V <sub>PN</sub>      | Supply Voltage                            | Applied Between P and N                                                             | -    | 300  | 450             | V    |
| V <sub>CC</sub>      | Control Supply Voltage                    | Applied Between V <sub>CC</sub> and COM                                             | 13.5 | 15.0 | 16.5            | V    |
| $V_{BS}$             | High-Side Bias Voltage                    | Applied Between $V_B$ and $V_S$                                                     | 13.5 | 15.0 | 16.5            | V    |
| V <sub>IN(ON)</sub>  | Input ON Threshold Voltage                |                                                                                     | 3.0  | -    | V <sub>CC</sub> | V    |
| V <sub>IN(OFF)</sub> | Input OFF Threshold Voltage               | Applied Between IN and COM                                                          | 0    | -    | 0.6             | V    |
| t <sub>dead</sub>    | Blanking Time for Preventing<br>Arm-Short | $V_{CC} = V_{BS} = 13.5 \sim 16.5 \text{ V}, \text{ T}_{J} \le 150^{\circ}\text{C}$ | 1.0  | -    | -               | μS   |
| f <sub>PWM</sub>     | PWM Switching Frequency                   | T <sub>J</sub> ≤ 150°C                                                              | -    | 20   | -               | kHz  |

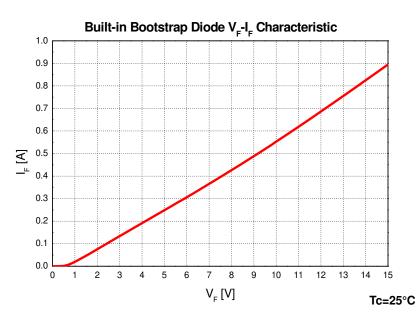
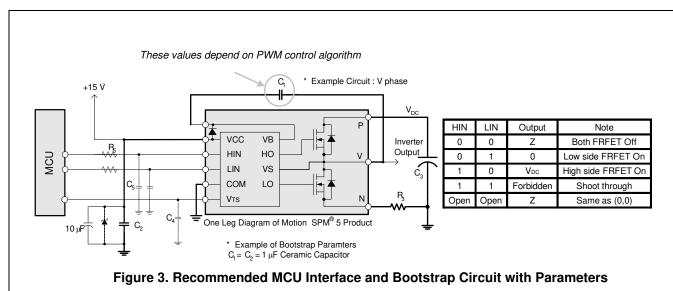


Figure 2. Built-in Bootstrap Diode Characteristics (Typical)

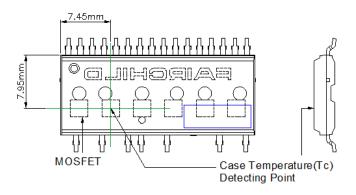


#### 3rd Notes:

1. Parameters for bootstrap circuit elements are dependent on PWM algorithm. For 15 kHz of switching frequency, typical example of parameters is shown above.

- 2. RC-coupling (R<sub>5</sub> and C<sub>5</sub>) and C<sub>4</sub> at each input of Motion SPM 5 product and MCU (Indicated as Dotted Lines) may be used to prevent improper signal due to surge-noise.
- Bold lines should be short and thick in PCB pattern to have small stray inductance of circuit, which results in the reduction of surge-voltage. Bypass capacitors such as C<sub>1</sub>, C<sub>2</sub> and C<sub>3</sub> should have good high-frequency characteristics to absorb high-frequency ripple-current.

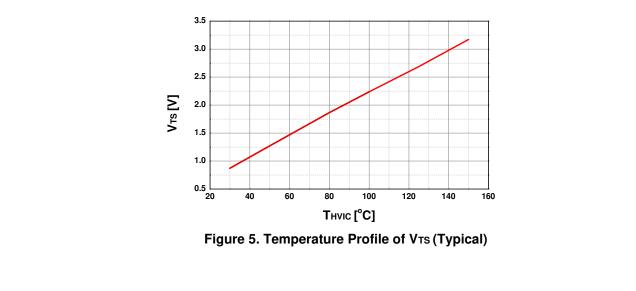




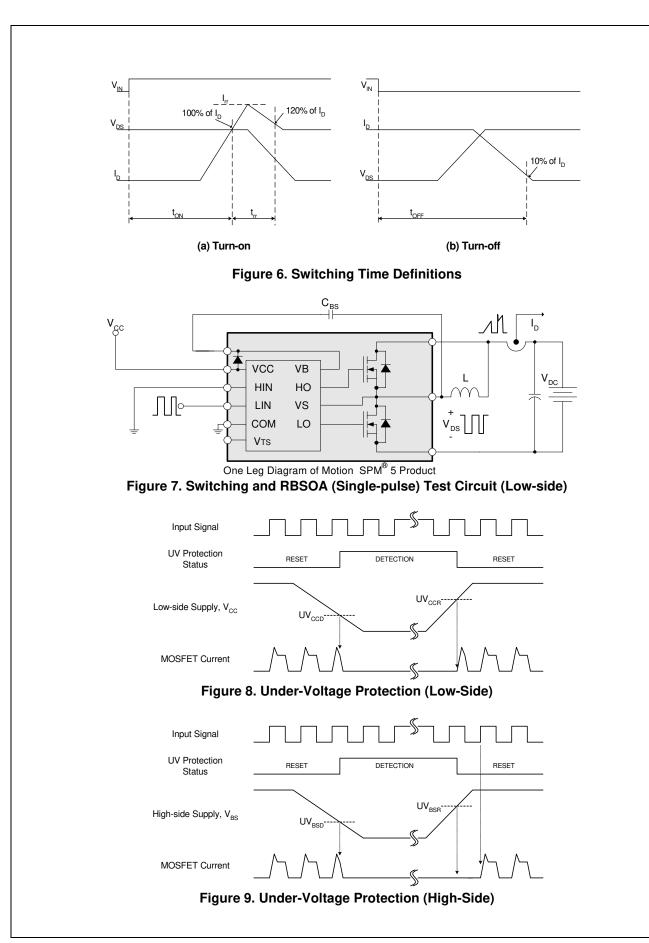
### Figure 4. Case Temperature Measurement

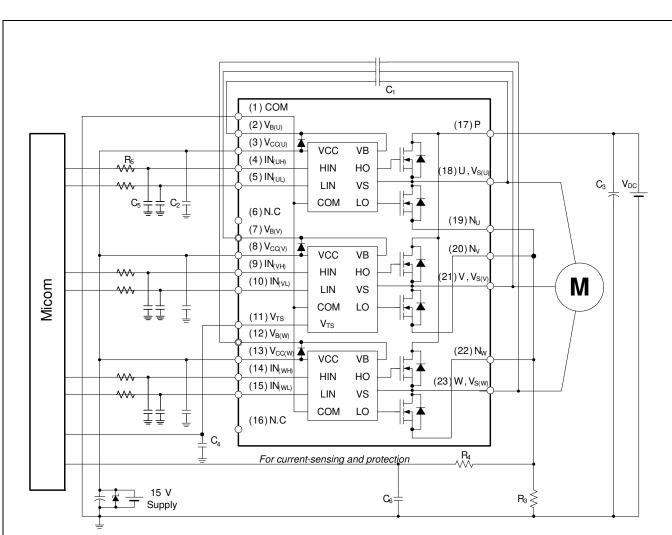
#### 3rd Notes:

4. Attach the thermocouple on top of the heat-sink of SPM 5 package (between SPM 5 package and heatsink if applied) to get the correct temperature measurement.



FSB50760SFS Motion SPM® 5 SuperFET® Series





## Figure 10. Example of Application Circuit

#### 4th Notes:

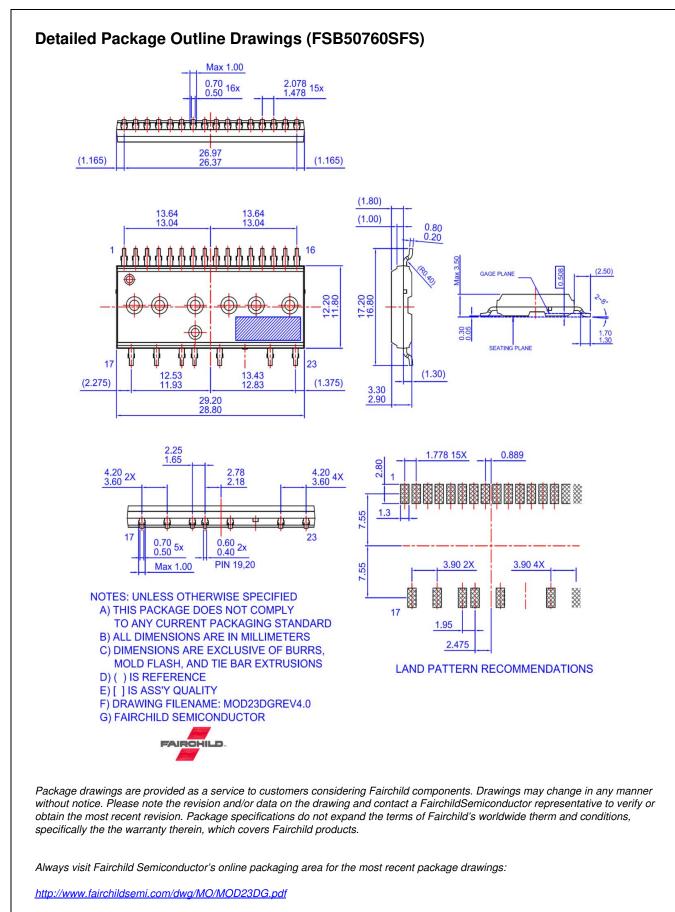
1. About pin position, refer to Figure 1.

2. RC-coupling (R<sub>5</sub> and C<sub>5</sub>, R<sub>4</sub> and C<sub>6</sub>) and C<sub>4</sub> at each input of Motion SPM<sup>®</sup> 5 product and MCU are useful to prevent improper input signal caused by surge-noise.

3. The voltage-drop across R<sub>3</sub> affects the low-side switching performance and the bootstrap characteristics since it is placed between COM and the source terminal of the lowside MOSFET. For this reason, the voltage-drop across R<sub>3</sub> should be less than 1 V in the steady-state.

4. Ground-wires and output terminals, should be thick and short in order to avoid surge-voltage and malfunction of HVIC.

5. All the filter capacitors should be connected close to Motion SPM 5 product, and they should have good characteristics for rejecting high-frequency ripple current.



| FAIRCHILD.                                                                                                                                                                                                             |                                                                                                                                                                                    |                                                                                                                                                                                                                                                                                                                                     |                                                                                                                                                                                                                                                                                    |
|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TRADEMARKS<br>The following includes registered<br>intended to be an exhaustive list                                                                                                                                   |                                                                                                                                                                                    | owned by Fairchild Semiconductor and/or its glob                                                                                                                                                                                                                                                                                    | al subsidiaries, and is not                                                                                                                                                                                                                                                        |
| AccuPower™<br>AttitudeEngine™<br>Awinda <sup>®</sup>                                                                                                                                                                   | F-PFS™<br>FRFET <sup>®</sup><br>Global Power Resource <sup>SM</sup>                                                                                                                | OPTOPLANAR <sup>®</sup>                                                                                                                                                                                                                                                                                                             | SYSTEM<br>GENERAL <sup>37</sup><br>TinyBoost <sup>®</sup>                                                                                                                                                                                                                          |
| AX-CAP <sup>®</sup> *<br>BitSiC™<br>Build it Now™<br>CorePLUS™<br>CorePOWER™<br><i>CROSSVOLT</i> ™<br>CTL™<br>CUTrent Transfer Logic™<br>DEUXPEED <sup>®</sup><br>Dual Cool™<br>EcoSPARK <sup>®</sup><br>EfficientMax™ | GreenBridge™<br>Green FPS™ e-Series™<br>Gmax™<br>GTO™<br>IntelliMAX™<br>ISOPLANAR™<br>Making Small Speakers Sound Louder<br>and Better™<br>MegaBuck™<br>MICROCOUPLER™<br>MicroFET™ | Power Supply WebDesigner™<br>PowerTrench®<br>PowerXS™<br>Programmable Active Droop™<br>QFET®<br>QS™<br>Quiet Series™<br>RapidConfigure™<br>O™<br>Saving our world, 1mW/W/kW at a time™<br>SignalWise™<br>SmartMax™                                                                                                                  | TinyBuck <sup>®</sup><br>TinyCalc <sup>™</sup><br>TinyLogic <sup>®</sup><br>TINYOPTO <sup>™</sup><br>TinyPOwer <sup>™</sup><br>TinyPWM <sup>™</sup><br>TinyWire <sup>™</sup><br>TranSiC <sup>™</sup><br>TranSiC <sup>™</sup><br>TRUECURRENT <sup>®</sup> *<br>µSerDes <sup>™</sup> |
| ESBC™<br>Fairchild <sup>®</sup><br>Fairchild Semiconductor <sup>®</sup><br>FACT Quiet Series™<br>FACT <sup>®</sup><br>FAST <sup>®</sup><br>FastvCore™<br>FETBench™<br>FFDS™                                            | MicroPak™<br>MicroPakZ™<br>MillerDrive™<br>MotionMax™<br>MotionGrid®<br>MTT®<br>MTX®<br>MVN®<br>mWSaver®<br>OptoHiT™<br>OPTOLOGIC®                                                 | SMART START <sup>™</sup><br>Solutions for Your Success <sup>™</sup><br>SPM <sup>®</sup><br>STEALTH <sup>™</sup><br>SuperFET <sup>®</sup><br>SuperSOT <sup>™</sup> -3<br>SuperSOT <sup>™</sup> -6<br>SuperSOT <sup>™</sup> -6<br>SuperSOT <sup>™</sup> -8<br>SupreMOS <sup>®</sup><br>SyncFET <sup>™</sup><br>Sync-Lock <sup>™</sup> | ScrDes <sup>®</sup><br>UHC <sup>®</sup><br>Ultra FRFET™<br>UniFET™<br>VCX™<br>VSualMax™<br>VoltagePlus™<br>XS <sup>™</sup><br>Xsens™<br>仙童™                                                                                                                                        |

\* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

#### DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. TO OBTAIN THE LATEST, MOST UP-TO-DATE DATASHEET AND PRODUCT INFORMATION, VISIT OUR WEBSITE AT <u>HTTP://www.fAIRCHILDSEMI.com</u>, FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

#### AUTHORIZED USE

Unless otherwise specified in this data sheet, this product is a standard commercial product and is not intended for use in applications that require extraordinary levels of quality and reliability. This product may not be used in the following applications, unless specifically approved in writing by a Fairchild officer: (1) automotive or other transportation, (2) military/aerospace, (3) any safety critical application – including life critical medical equipment – where the failure of the Fairchild product reasonably would be expected to result in personal injury, death or property damage. Customer's use of this product is subject to agreement of this Authorized Use policy. In the event of an unauthorized use of Fairchild's product, Fairchild accepts no liability in the event of product failure. In other respects, this product shall be subject to Fairchild's Worldwide Terms and Conditions of Sale, unless a separate agreement has been signed by both Parties.

#### ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Terms of Use

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

#### PRODUCT STATUS DEFINITIONS

| Datasheet Identification Product Status |                       | Definition                                                                                                                                                                                             |  |
|-----------------------------------------|-----------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|--|
| Advance Information                     | Formative / In Design | Datasheet contains the design specifications for product development. Specifications may change<br>in any manner without notice.                                                                       |  |
| Preliminary                             | First Production      | Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild<br>Semiconductor reserves the right to make changes at any time without notice to improve design. |  |
| No Identification Needed                | Full Production       | Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make<br>changes at any time without notice to improve the design.                                               |  |
| Obsolete                                | Not In Production     | Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor.<br>The datasheet is for reference information only.                                                    |  |

Rev. 175

FSB50760SFS Motion SPM® 5 SuperFET® Series

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

#### PUBLICATION ORDERING INFORMATION

#### LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC